ON Semiconductor

Is Now



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Silicon Power Transistors

The NJW21193G and NJW21194G utilize Perforated Emitter technology and are specifically designed for high power audio output, disk head positioners and linear applications.

Features

- Total Harmonic Distortion Characterized
- High DC Current Gain
- Excellent Gain Linearity
- High SOA
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	250	Vdc
Collector-Base Voltage	V _{CBO}	400	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector-Emitter Voltage - 1.5 V	V _{CEX}	400	Vdc
Collector Current - Continuous	I _C	16	Adc
Collector Current - Peak (Note 1)	I _{CM}	30	Adc
Base Current - Continuous	I _B	5.0	Adc
Total Power Dissipation @ T _C = 25°C Derate Above 25°C	P _D	200 1.6	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	– 65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5 μs, Duty Cycle ≤ 10%.

THERMAL CHARACTERISTICS

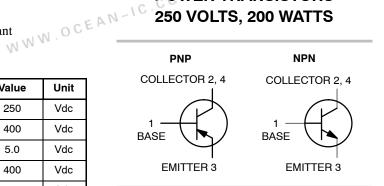
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.625	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

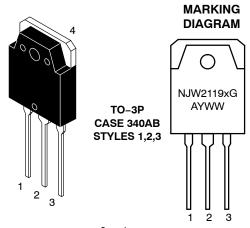


ON Semiconductor®

http://onsemi.com

16 AMPERES
COMPLEMENTARY SILICON
POWER TRANSISTORS
250 VOLTS, 200 WATTS





 X
 = 3 or 4

 G
 = Pb-Free Package

 A
 = Assembly Location

 Y
 = Year

 WW
 = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NJW21193G	TO-3P (Pb-Free)	30 Units/Rail
NJW21194G	TO-3P (Pb-Free)	30 Units/Rail

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•		•	-
Collector–Emitter Sustaining Voltage (I _C = 100 mAdc, I _B = 0)	V _{CEO(sus)}	250	-	-	Vdc
Collector Cutoff Current (V _{CE} = 200 Vdc, I _B = 0)	I _{CEO}	_	-	100	μAdc
Emitter Cutoff Current (V _{CE} = 5 Vdc, I _C = 0)	I _{EBO}	-	-	100	μAdc
Collector Cutoff Current (V _{CE} = 250 Vdc, V _{BE(off)} = 1.5 Vdc)	I _{CEX}	-	-	100	μAdc
SECOND BREAKDOWN		_			
Second Breakdown Collector Current with Base Forward Biased (V _{CE} = 50 Vdc, t = 1 s (non-repetitive) (V _{CE} = 80 Vdc, t = 1 s (non-repetitive)	I _{S/b}	4.0 2.25	- -		Adc
ON CHARACTERISTICS	, OCEAN-			1	
DC Current Gain ($I_C = 8$ Adc, $V_{CE} = 5$ Vdc) ($I_C = 16$ Adc, $I_B = 5$ Adc)	h _{FE}	20 8	- -	80 -	
Base-Emitter On Voltage (I _C = 8 Adc, V _{CE} = 5 Vdc)	V _{BE(on)}	_	_	2.2	Vdc
Collector–Emitter Saturation Voltage ($I_C = 8$ Adc, $I_B = 0.8$ Adc) ($I_C = 16$ Adc, $I_B = 3.2$ Adc)	V _{CE(sat)}	- -	- -	1.4 4	Vdc
DYNAMIC CHARACTERISTICS					
Total Harmonic Distortion at the Output V _{RMS} = 28.3 V, f = 1 kHz, P _{LOAD} = 100 W _{RMS} h _{FE}	T _{HD}		0.8		%
(Matched pair h_{FE} = 50 @ 5 A/5 V) unmatched h_{FE} matched		_	0.08	_	
Current Gain Bandwidth Product (I _C = 1 Adc, V _{CE} = 10 Vdc, f _{test} = 1 MHz)	f _T	4	_	-	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1 MHz)	C _{ob}	_	_	500	pF

PNP NJW21193G 6.5 6.0 V_{CE} = 10 V 4.5 4.0 4.5 4.0 1.0 I_C COLLECTOR CURRENT (AMPS)

I_C COLLECTOR CURRENT (AMPS)

Figure 1. Typical Current Gain
Bandwidth Product

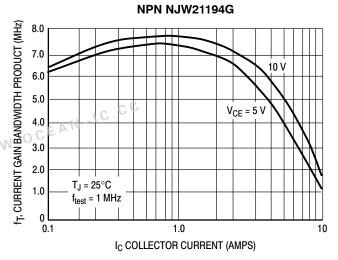


Figure 2. Typical Current Gain Bandwidth Product

TYPICAL CHARACTERISTICS

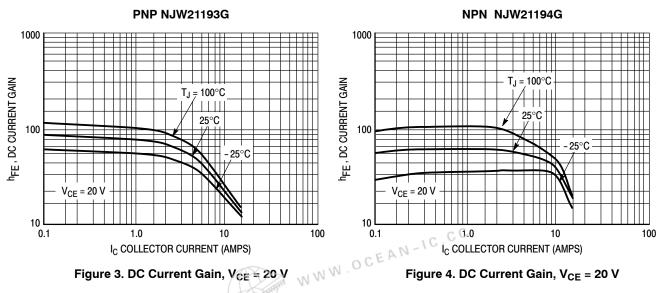


Figure 3. DC Current Gain, V_{CE} = 20 V

Figure 4. DC Current Gain, V_{CE} = 20 V

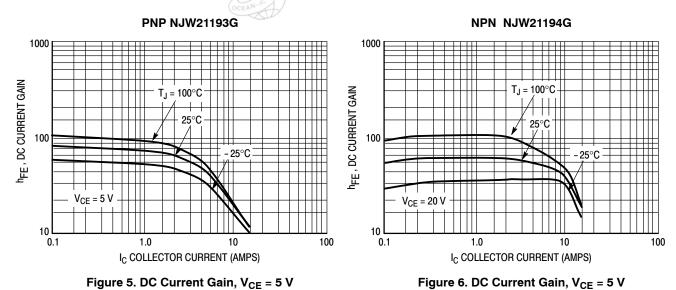
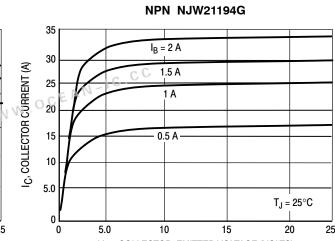


Figure 5. DC Current Gain, V_{CE} = 5 V



PNP NJW21193G

30 1.5 A $I_B = 2 A$ 25 I_C, COLLECTOR CURRENT (A) 20 1 A 15 0.5 A 10 5.0 $T_J=25^{\circ}C$ 0 25 0 5.0 V_{CE} , COLLECTOR-EMITTER VOLTAGE (VOLTS)

Figure 7. Typical Output Characteristics

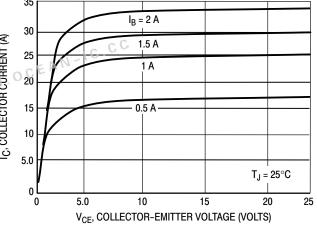


Figure 8. Typical Output Characteristics

TYPICAL CHARACTERISTICS

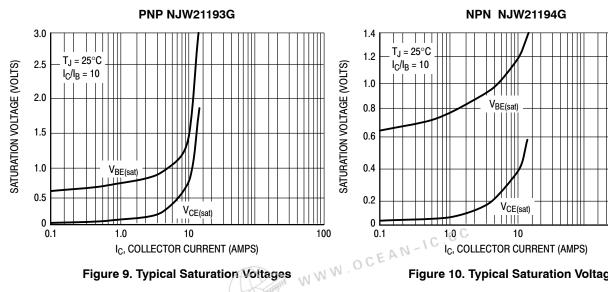


Figure 9. Typical Saturation Voltages

Figure 10. Typical Saturation Voltages

100

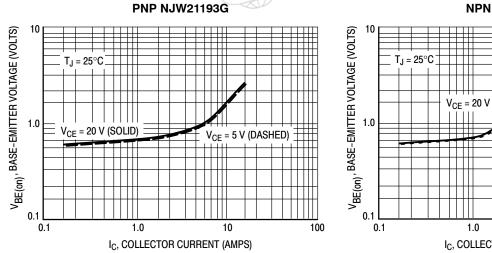


Figure 11. Typical Base-Emitter Voltage

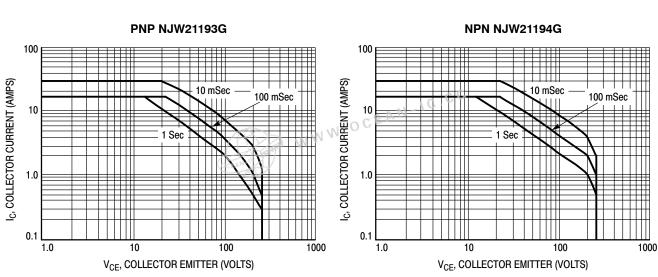


Figure 13. Active Region Safe Operating Area

Figure 14. Active Region Safe Operating Area

NPN NJW21194G

V_{CE} = 20 V (SOLID) 100 IC, COLLECTOR CURRENT (AMPS)

Figure 12. Typical Base-Emitter Voltage

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 13 is based on $T_{J(pk)} = 150^{\circ}C$; T_{C} is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

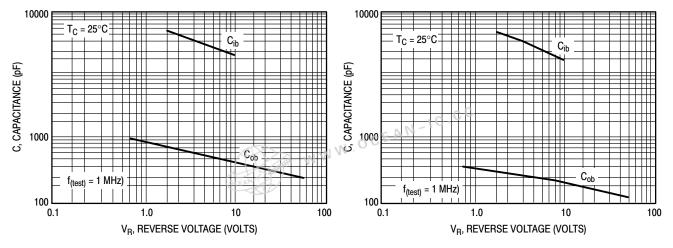


Figure 15. NJW21193G Typical Capacitance

Figure 16. NJW21194G Typical Capacitance

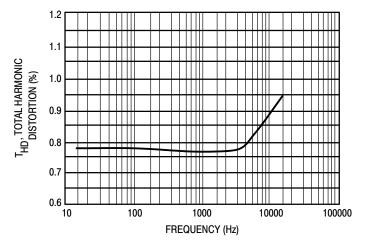
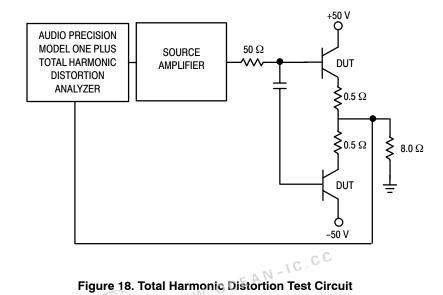


Figure 17. Typical Total Harmonic Distortion



5



MMN

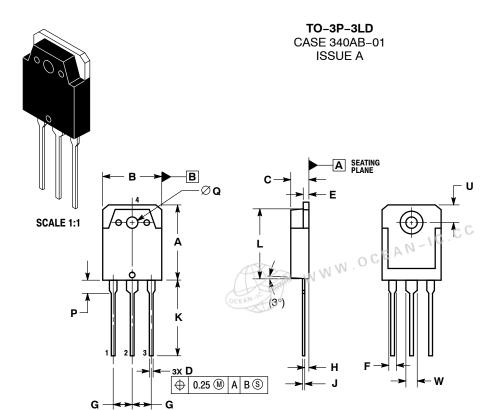


STYLE 1: PIN 1. BASE

2. COLLECTOR

EMITTER

COLLECTOR



STYLE 3:

PIN 1. GATE

2. DRAIN

SOURCE

DRAIN

STYLE 2:

PIN 1.

2.

ANODE CATHODE

CATHODE

ANODE

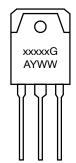
DATE 30 OCT 2007

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2 CONTROLLING DIMENSION: MILLIMETERS
 3. DIMENSION & APPLIES TO PLATED TERMINAL
 AND IS MEASURED BETWEEN 0.15 AND 0.30mm
- FROM THE TERMINAL TIP. DIMENSION A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	19.70	19.90	20.10	
В	15.40	15.60	15.80	
С	4.60	4.80	5.00	
D	0.80	1.00	1.20	
E	1.45	1.50	1.65	
F	1.80	2.00	2.20	
G	5.45 BSC			
Н	1.20	1.40	1.60	
J	0.55	0.60	0.75	
K	19.80	20.00	20.20	
L	18.50	18.70	18.90	
P	3.30	3.50	3.70	
Q	3.10	3.20	3.50	
U	5.00 REF			
W	2.80	3.00	3.20	

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Pb-Free Package G = Assembly Location Α

WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Ph_Fro-

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